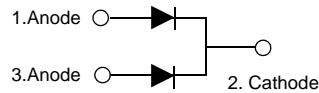
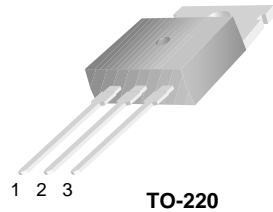


# FYP2010DN

## Schottky Barrier Rectifier

### Features

- Low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	100	V
$V_R$	Maximum DC Reverse Voltage	100	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 120^\circ\text{C}$	20	A
$I_{FSM}$	Non-repetitive Peak Surge Current (per diode) 60Hz Single Half-Sine Wave	150	A
$T_J, T_{STG}$	Operating Junction and Storage Temperature	-65 to +150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case (per diode)	1.7	$^\circ\text{C}/\text{W}$

### Electrical Characteristics (per diode)

Symbol	Parameter	Value	Units
$V_{FM}^*$	Maximum Instantaneous Forward Voltage		
	$I_F = 10\text{A}$	$T_C = 25^\circ\text{C}$	0.77
	$I_F = 10\text{A}$	$T_C = 125^\circ\text{C}$	0.65
	$I_F = 20\text{A}$	$T_C = 25^\circ\text{C}$	-
$I_{RM}^*$	Maximum Instantaneous Reverse Current @ rated $V_R$	$T_C = 25^\circ\text{C}$	0.1
		$T_C = 125^\circ\text{C}$	20

\* Pulse Test: Pulse Width=300 $\mu\text{s}$ , Duty Cycle=2%

### Typical Performance Characteristics

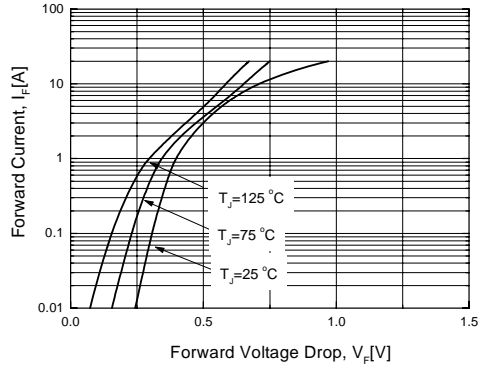


Figure 1. Typical Forward Voltage Characteristics (per diode)

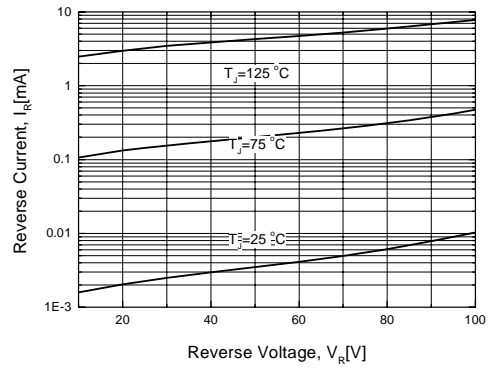


Figure 2. Typical Reverse Current vs. Reverse Voltage (per diode)

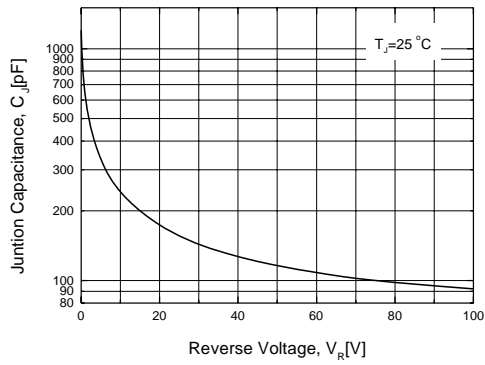


Figure 3. Typical Junction Capacitance (per diode)

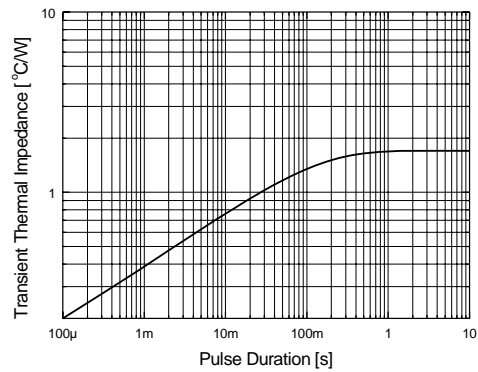


Figure 4. Thermal Impedance Characteristics (per diode)

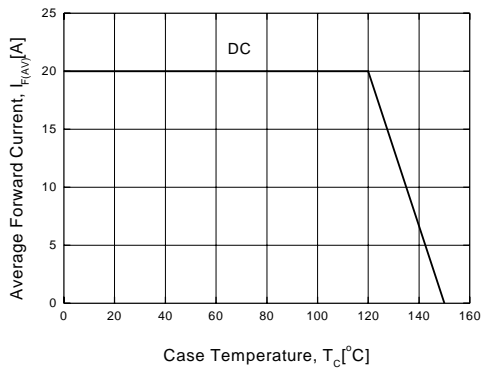


Figure 5. Forward Current Derating Curve

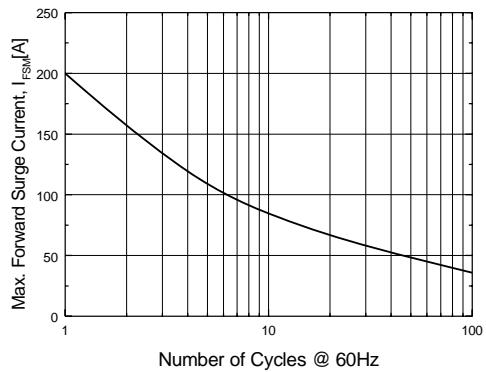
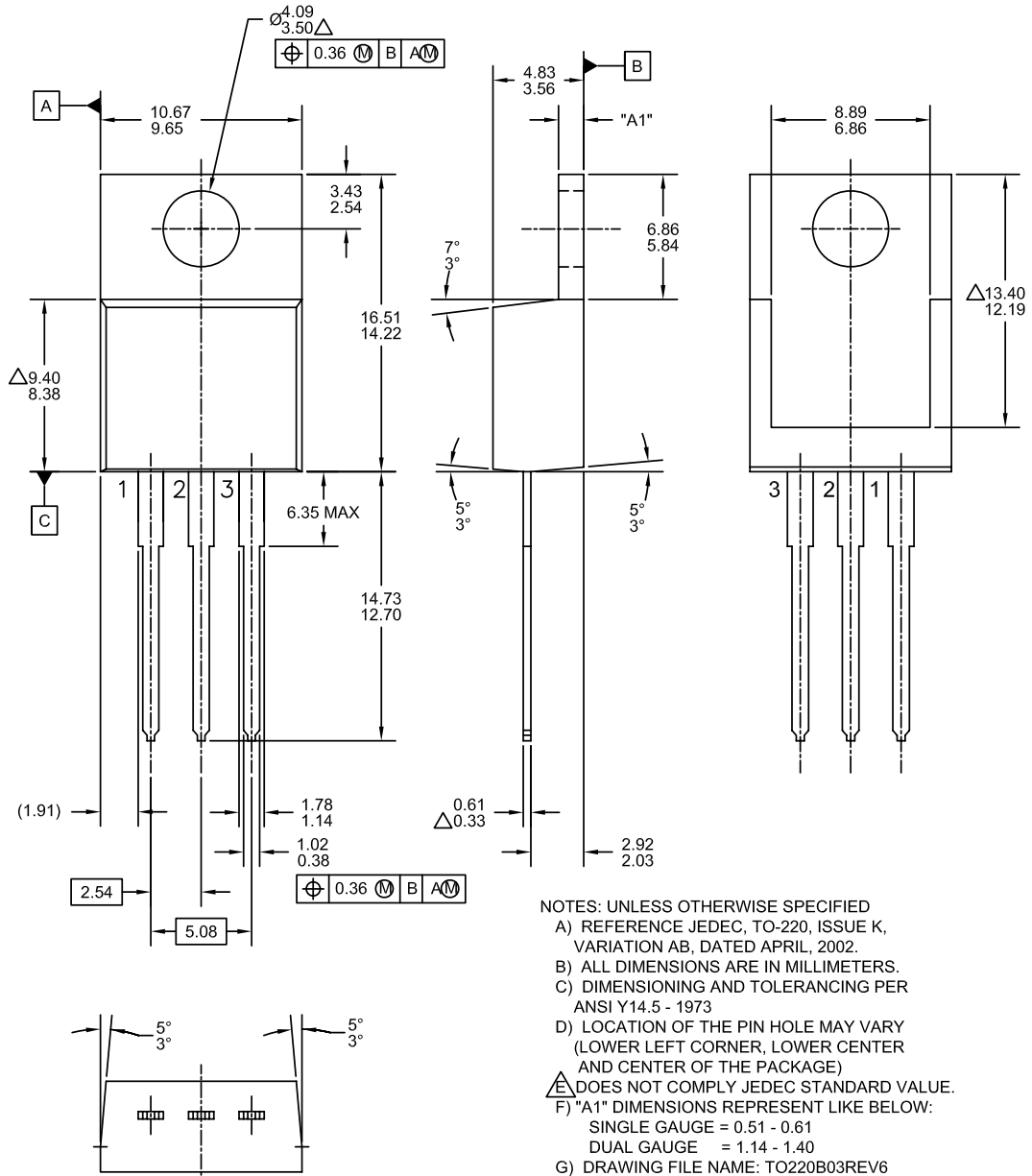


Figure 6. Non-Repetitive Surge Current (per diode)

Physical Dimensions







TO-220





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